

□□ □□

□□	SFENG
□□ □□	SF-P50
□□□	□□
□	□□
□	SUS □□ □□ □□□
□ □□	100g
□□ □□	2.5 (0.0984 ")
□□ □□	1.5A
□□ □□	50mW
□□	1.27 (0.0500"0
□□ □□ □□	0.90 (0.0354 ") / 0.95 (0.0374 ")
MOQ	100 □
□□ □□	7 □ □□□□□ □

□□ □□

胜峰探针
SFENG
The China's The World's

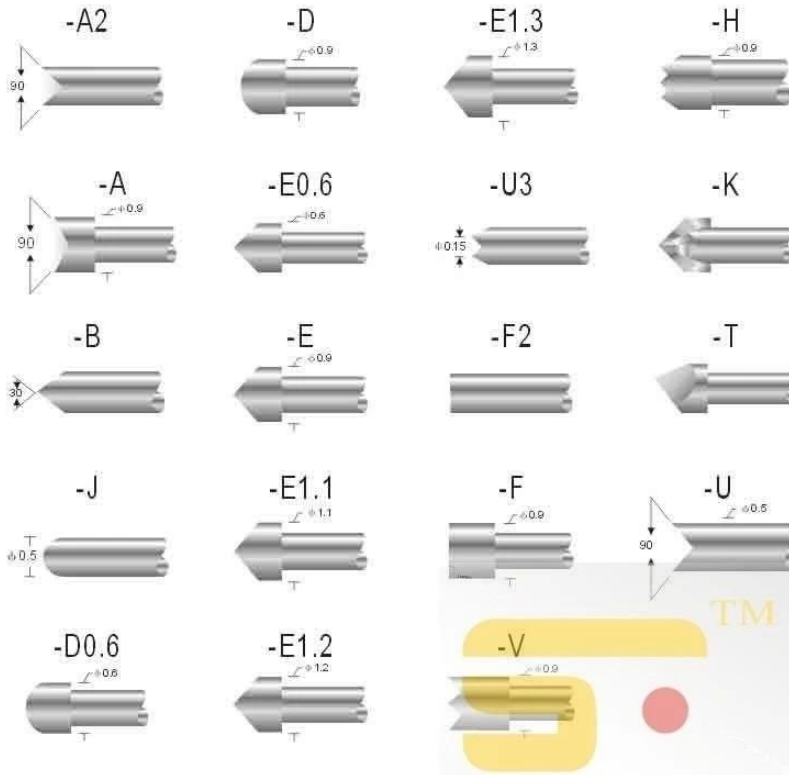
RoHS

QUALITY ASSURED FIRM
ISO 9001
SGS

CE

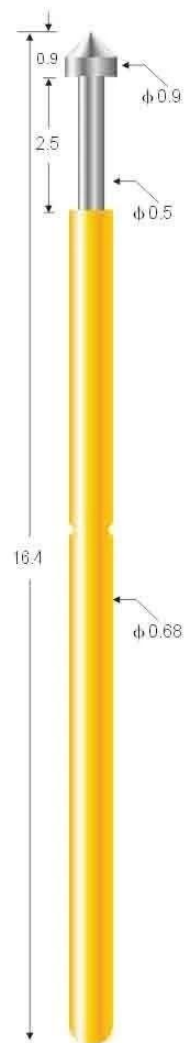
chinapogopinsupplier.com

SF-P50



Probe specifications SF-P50(技术规格)

- Recommended minimum center(最小间距):
1.27mm(.0500 ")
- Mounting hole size(钻孔尺寸):
V: 0.90mm(.0354 ")
W: 0.95mm(.0374 ")
- Full travel(行程): 2.5(.0984 ")
- Spring force(弹簧压力): 100g
- Materials and finishes(材料及涂饰):
Plunger: Be Cu, Rh plated; SK4, Rh plated
Barrel: Phosphor bronze, Gold plated
Spring: Stainless steel
- Current ration(额定电流): 1.5A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)



SF-P50-E

www.shengfengdz.com

□□ □□

1. □□□ 24 □□ □□ □□ □□ □ □ □□□□.

2. □□□ □□ □□□□ □□□ □ □□□□ □ OEM □ □□□□□.

3. 3D printing process and its applications.

4. 3D printing process and its applications.

3D Printing

PCB, ICT, FCT 3D printing applications (3D)

3D (3D) printing process and its applications, 3D, 3D, 3D & A; 3D 3D 3D 3D 3D;

BGA 3D printing applications 3D 3D 3D;







3D 3D 3D, 3D 3D, QZ 3D VZ 3D LM 3D;

3D 3D 3D, 3D 3D, 3D 3D 3D;

3D & A; 3D / 3D;

3D 3D 3D 3D, 30 # 3D 3D, 3D 3D 3D, POM, 3D 3D 3D

3D Printing

Spring exhausted tester	DC power supply	Current resistance tester
		
Microscope	Tensile strength tester	Spring tester
		

□ □ □

